

#### **Features**

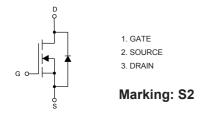
- · Rugged and Reliable
- · Lead Free Product is Acquired
- High Dense Cell Design for Extremely Low R<sub>DS(ON)</sub>
- · Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- · Halogen Free Available Upon Request by Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

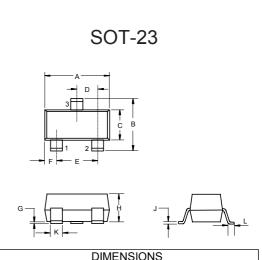
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 100°C/W Junction to Ambient

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	$V_{GS}$	±8	V
Drain Current-Continuous	I <sub>D</sub>	3.0	Α
Drain Current-Pulsed <sup>(Note1)</sup>	I <sub>DM</sub>	10	Α
Power Dissipation	P <sub>D</sub>	1.25	W

## **Internal Structure**

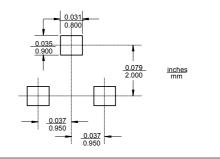


# N-Channel Enhancement Mode Field Effect Transistor



DIMENSIONS					
DIM INC		INCHES		М	NOTE
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.110	0.120	2.80	3.04	
В	0.083	0.104	2.10	2.64	
С	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
Н	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

#### **Suggested Solder Pad Layout**





# ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Static Characteristics	ı		,			
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =10μA	20			V
Gate-Threshold Voltage <sup>(Note3)</sup>	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=50\mu A$	0.65		1.2	V
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =± 8V, V <sub>DS</sub> =0V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μA
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =3.6A		55	72 mΩ	
Drain-Source On-Resistance <sup>(Note3)</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =2.5V, I <sub>D</sub> =3.1A	82		110	11122
Forward Transconductance <sup>(Note3)</sup>	<b>g</b> FS	V <sub>DS</sub> =5V, I <sub>D</sub> =3.6A		8.5		S
Dynamic Characteristics(Note4)						
Input Capacitance	C <sub>iss</sub>			237		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V, f=1MHz		120		рF
Reverse Transfer Capacitance	C <sub>rss</sub>			45		
Switching Characteristics(Note4)	1			I		
Turn-On Delay Time	t <sub>d(on)</sub>			23	45	
Turn-On Rise Time	t <sub>r</sub>	$V_{DD}$ =10V, $V_{GS}$ =4.5V, $I_{D}$ =3.6A, $R_{GEN}$ =6 $\Omega$		11	30	no
Turn-Off Delay Time	t <sub>d(off)</sub>	10 0.07 (, T(GEN 032		34	70	ns
Turn-Off Fall Time	t <sub>f</sub>			36	70	
Total Gate Charge	Qg			6	10	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =3.6A		1.4		nC
Gate-Drain Charge	$Q_{gd}$			1.8		
Drain-Source Diode Character	ristics and	d Maximum Ratings	1		1	
Diode Forward Voltage <sup>(Note3)</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =0.94A			1.2	V
Drain-Source Diode Forward Current(Note2	l <sub>s</sub>				0.94	Α

## Notes:

<sup>1.</sup>Repetitive Rating : Pulse Width limited By Maximum Junction Temperature.

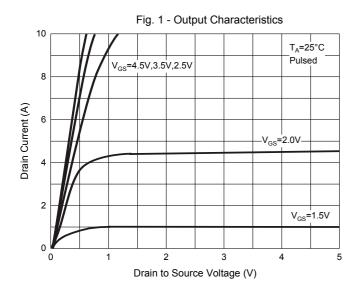
<sup>2.</sup>Surface Mounted on FR4 Board, t < 10 sec.

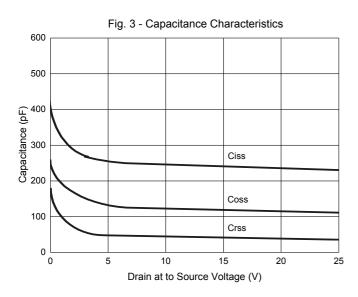
<sup>3.</sup>Pulse Test : Pulse Width < 300 µs, Duty Cycle < 2%.

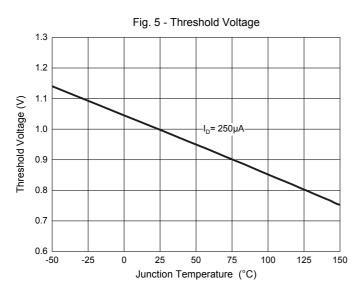
<sup>4.</sup> Guaranteed By Design, Not Subject to Production Testing.

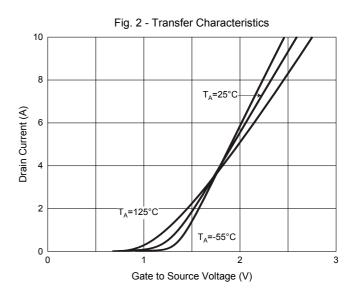


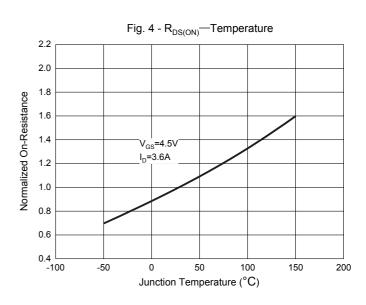
### **Curve Characteristics**

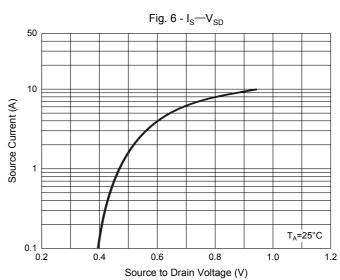














# **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

Note: Adding "-HF" Suffix For Halogen Free, eg. Part Number-TP-HF

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